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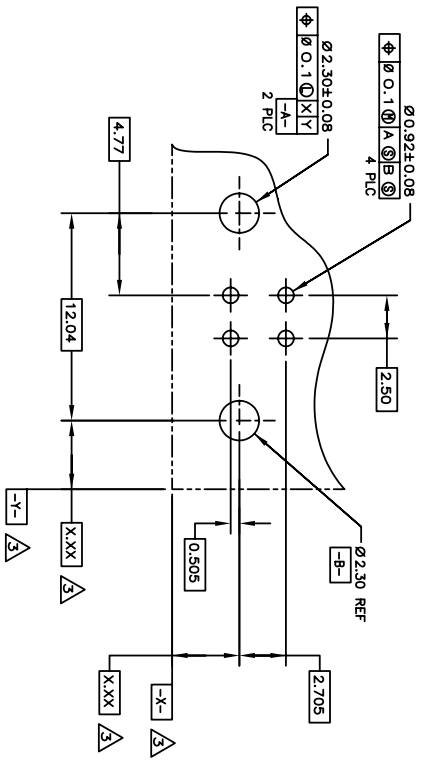
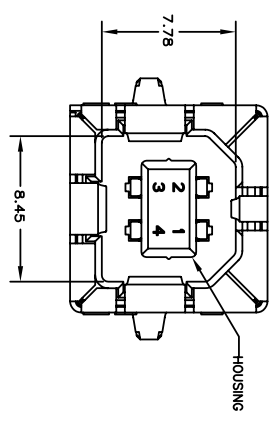
4

3

2

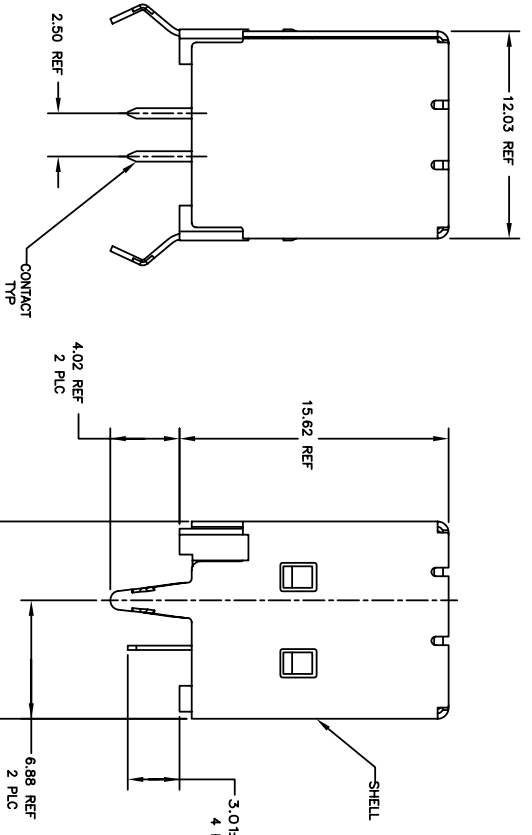
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REV	DATE	DESCRIPTION	DATE	REV	APP'D
ES 00					
A		REVISED FB00-0215-04	16DEC04		C.Z. I.E.



LEAD FREE

PC BOARD MOUNTING DIMENSIONS



- △ MATERIAL: SHELL & CONTACTS - COPPER ALLOY; HOUSING - UL 94V-0 RATED, THERMOPLASTIC, FOR COLOR SEE TABLE.
- △ PLATING: CONTRACTS - 0.076um MINIMUM GOLD OVER 0.76um MINIMUM PALLADIUM-NICKEL ON MATING AREA, 3.8um MINIMUM NICKEL, BOTH OVER 1.27um MINIMUM MATTE TIN ON SOLDER TAILS, CONTACT ALTERNATE PLATING: 0.76um MINIMUM GOLD ON MATING AREA, 3.80um MINIMUM MATTE TIN ON SOLDER TAILS, BOTH OVER 1.27um MINIMUM BRIGHT TIN.
- △ SHELL - 2-3um MINIMUM BRIGHT TIN.
- △ DATUM AND BASIC DIMENSIONS ESTABLISHED BY CUSTOMER.
- △ RECOMMENDED PC BOARD THICKNESS OF 1.57mm.

DIMENSIONS		TOLERANCES		FINISHES	
0 PLG	± 0.1	0 PLG	± 0.1	0 PLG	± 0.1
2 PLG	± 0.05	2 PLG	± 0.05	2 PLG	± 0.05
4 PLG	± 0.05	4 PLG	± 0.05	4 PLG	± 0.05
2 PLG	± 0.05	2 PLG	± 0.05	2 PLG	± 0.05
4 PLG	± 0.05	4 PLG	± 0.05	4 PLG	± 0.05

DESIGNER	YAO	DATE	200404
CHECKER	YAO	DATE	200404
APPROVER	SHEN	DATE	200404
REVISION		DATE	
REVISION		DATE	
REVISION		DATE	

SIZE	A2	DATE	00779	REV	1
SCALE	5:1	DATE	05787834	REV	1
SHEET	1	DATE	05787834	REV	1
TOTAL	1	DATE	05787834	REV	1

5787834